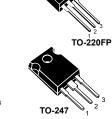
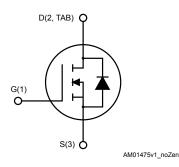


# N-channel 650 V, 0.124 $\Omega$ , 22 A, MDmesh M5 Power MOSFETs in D<sup>2</sup>PAK, TO-220FP, TO-220 and TO-247 packages







### **Features**

Order code	V <sub>DS</sub> @ T <sub>JMAX</sub>	R <sub>DS(on)</sub> max.	I <sub>D</sub>	Package
STB31N65M5				D <sup>2</sup> PAK
STF31N65M5	710 V	0.148 Ω	22 A	TO-220FP
STP31N65M5	710 V	0.140 12	22 A	TO-220
STW31N65M5				TO-247

Extremely low R<sub>DS(on)</sub>

- Low gate charge and input capacitance
- Excellent switching performance
- 100% avalanche tested

### **Applications**

Switching applications

#### **Description**

lectronics sales office

These devices are N-channel Power MOSFETs based on the MDmesh M5 innovative vertical process technology combined with the well-known PowerMESH horizontal layout. The resulting products offer extremely low on-resistance, making them particularly suitable for applications requiring high power and superior efficiency.



Product status link
STB31N65M5
STF31N65M5
STP31N65M5
STW31N65M5



### 1 Electrical ratings

		Value		
Symbol	Parameter	D²PAK, TO-220, TO-247	TO-220FP	Unit
V <sub>GS</sub>	Gate-source voltage	±25		V
ID	Drain current (continuous) at T <sub>C</sub> = 25 °C	22	22 (1)	А
I <sub>D</sub>	Drain current (continuous) at T <sub>C</sub> = 100 °C	13.9	13.9 (1)	А
I <sub>DM</sub> <sup>(2)</sup>	Drain current (pulsed)	88	88 (1)	А
P <sub>TOT</sub>	Total power dissipation at T <sub>C</sub> = 25 °C	150	30	W
V <sub>ISO</sub>	Insulation withstand voltage (RMS) from all three leads to external heat-sink (t = 1 s, $T_C = 25$ °C)		2500	V
dv/dt (3)	Peak diode recovery voltage slope	15		\//
dv/dt (4)	MOSFET dv/dt ruggedness	50		V/ns
Tj	Operating junction temperature range	-55 to 150		°C
T <sub>stg</sub>	Storage temperature range	-55 (0 150		

#### Table 1. Absolute maximum ratings

1. Limited by package.

2. Limited by maximum junction temperature.

3.  $I_{SD} \leq 22$  A, di/dt  $\leq 400$  A/µs;  $V_{DS}$  (peak)  $< V_{(BR)DSS}$ ,  $V_{DD} = 400$  V.

 $4. \quad V_{DS} \leq 480 \ V.$ 

#### Table 2. Thermal data

Symbol	Parameter			Value		Unit
Symbol	r ai ailletei	D <sup>2</sup> PAK	TO-220	TO-220FP	TO-247	Unit
R <sub>thj-case</sub>	Thermal resistance junction-case	0.	.83	4.17	0.83	°C/W
R <sub>thj-amb</sub>	Thermal resistance junction-ambient			62.5	50	°C/W
R <sub>thj-pcb</sub> <sup>(1)</sup>	Thermal resistance junction-pcb	30				°C/W

1. When mounted on FR-4 board of 1 inch<sup>2</sup>, 2 oz Cu.



#### Table 3. Avalanche characteristics

Symbol	Parameter	Value	Unit
I <sub>AR</sub>	Avalanche current, repetitive or not repetitive (pulse width limited by T <sub>jmax</sub> )	5	A
E <sub>AS</sub>	Single pulse avalanche energy (starting T <sub>j</sub> = 25 °C, I <sub>D</sub> = I <sub>AR</sub> , $V_{DD}$ = 50 V)	410	mJ



### 2 Electrical characteristics

#### $T_C$ = 25 °C unless otherwise specified

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V <sub>(BR)DSS</sub>	Drain-source breakdown voltage	$V_{GS}$ = 0 V, I <sub>D</sub> = 1 mA	650			V
		$V_{GS}$ = 0 V, $V_{DS}$ = 650 V			1	μA
I <sub>DSS</sub>	Zero gate voltage drain current	$V_{GS}$ = 0 V, $V_{DS}$ = 650 V, T <sub>C</sub> = 125 °C <sup>(1)</sup>			100	μA
I <sub>GSS</sub>	Gate body leakage current	$V_{DS}$ = 0 V, $V_{GS}$ = ±25 V			±100	nA
V <sub>GS(th)</sub>	Gate threshold voltage	$V_{DS}$ = $V_{GS}$ , $I_D$ = 250 $\mu$ A	3	4	5	V
R <sub>DS(on)</sub>	Static drain-source on-resistance	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 11 A		0.124	0.148	Ω

#### Table 4. On/off-state

1. Defined by design, not subject to production test.

#### Table 5. Dynamic

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
C <sub>iss</sub>	Input capacitance	V <sub>DS</sub> = 100 V, f = 1 MHz,	-	1865	-	pF
C <sub>oss</sub>	Output capacitance	$V_{\rm DS} = 100$ V, 1 = 1 MHz, $V_{\rm GS} = 0$ V	-	45	-	pF
C <sub>rss</sub>	Reverse transfer capacitance	VGS - V V	-	4.2	-	pF
C <sub>o(tr)</sub> <sup>(1)</sup>	Equivalent capacitance time related	V <sub>GS</sub> = 0 V,	-	146	-	pF
C <sub>o(er)</sub> <sup>(2)</sup>	Equivalent capacitance energy related	V <sub>DS</sub> = 0 to 520 V	-	43	-	pF
Rg	Intrinsic gate resistance	f = 1 MHz	-	2.8	-	Ω
Qg	Total gate charge	V <sub>DD</sub> = 520 V, I <sub>D</sub> = 11 A	-	45	-	nC
Q <sub>gs</sub>	Gate-source charge	V <sub>GS</sub> = 0 to 10 V	-	11.5	-	nC
Q <sub>gd</sub>	Gate-drain charge	(see Figure 18. Test circuit for gate charge behavior)	-	20	-	nC

1.  $C_{o(tr)}$  is defined as a constant equivalent capacitance giving the same charging time as  $C_{oss}$  when  $V_{DS}$  increases from 0 to 80%  $V_{DSS}$ .

2.  $C_{o(er)}$  is defined as a constant equivalent capacitance giving the same stored energy as  $C_{oss}$  when  $V_{DS}$  increases from 0 to 80%  $V_{DSS}$ .



#### Table 6. Switching times

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t <sub>d(v)</sub>	Voltage delay time	V <sub>DD</sub> = 400 V, I <sub>D</sub> = 14 A,	-	46	-	ns
t <sub>r(v)</sub>	Voltage rise time	R <sub>G</sub> = 4.7 Ω	-	8	-	ns
t <sub>f(i)</sub>	Current fall time	V <sub>GS</sub> = 10 V	-	8.5	-	ns
t <sub>c(off)</sub>	Crossing time	(see Figure 19. Test circuit for inductive load switching and diode recovery times and Figure 22. Switching time waveform)	-	11	-	ns

#### Table 7. Source-drain diode

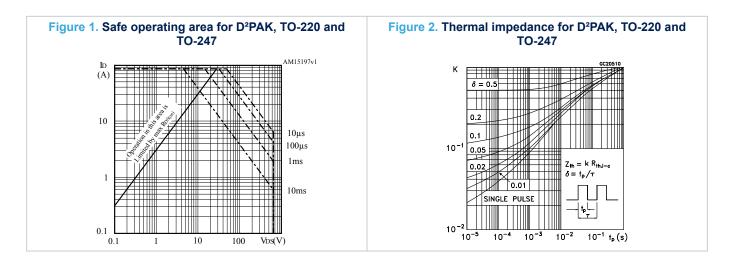
Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
I <sub>SD</sub>	Source-drain current		-		22	А
I <sub>SDM</sub> <sup>(1)</sup>	Source-drain current (pulsed)		-		88	А
V <sub>SD</sub> <sup>(2)</sup>	Forward on voltage	I <sub>SD</sub> = 22 A, V <sub>GS</sub> = 0 V	-		1.5	V
t <sub>rr</sub>	Reverse recovery time	$I_{SD} = 22 \text{ A}, \text{ di/dt} = 100 \text{ A/}\mu\text{s},$	-	336		ns
Q <sub>rr</sub>	Reverse recovery charge	V <sub>DD</sub> = 100 V (see Figure 19. Test circuit for	-	5		μC
I <sub>RRM</sub>	Reverse recovery current	inductive load switching and diode recovery times)	-	30		А
t <sub>rr</sub>	Reverse recovery time	I <sub>SD</sub> = 22 A, di/dt = 100 A/μs,	-	406		ns
Q <sub>rr</sub>	Reverse recovery charge	$V_{DD}$ = 100 V, T <sub>j</sub> = 150 °C ( see	-	6		μC
I <sub>RRM</sub>	Reverse recovery current	<ul> <li>Figure 19. Test circuit for inductive load switching and diode recovery times)</li> </ul>	-	31		A

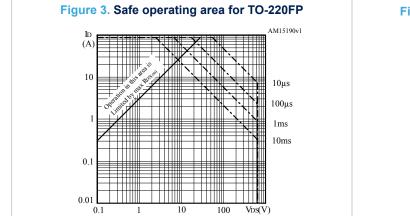
1. Pulse width limited by safe operating area

2. Pulsed: pulse duration = 300 µs, duty cycle 1.5%



### 2.1 Electrical characteristics (curves)





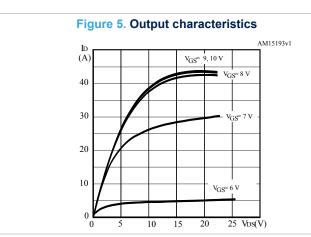


Figure 4. Thermal impedance for TO-220FP К  $\delta = 0.5$ 0.2 1 0.1 10 0.05  $Z_{th} = k R_{thJ-c}$ 0.02  $\delta = t_{\rm P} / \tau$ 4 0.01 SINGLE PULSE 10-2 10-3  $10^{0} t_{p}(s)$ 10-4 10<sup>-2</sup> 10-1

Figure 6. Transfer characteristics

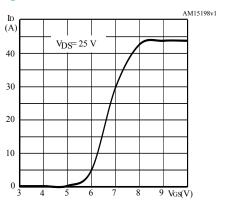
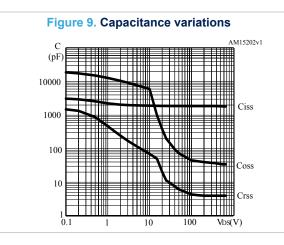
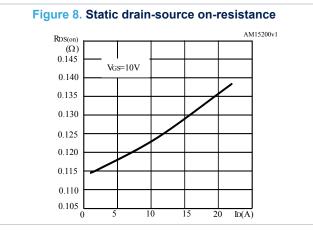
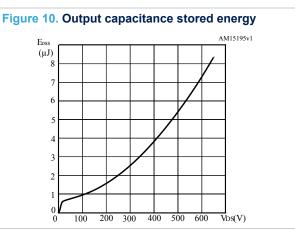




Figure 7. Gate charge vs gate-source voltage AM15199v1 VGS (V) VDS VDD=520V (V) 12 ·500 ID=11A VDS 10 400 8 300 6  $\cdot 200$ 4 100 2 0 0 50 Qg(nČ) 10 20 30 40

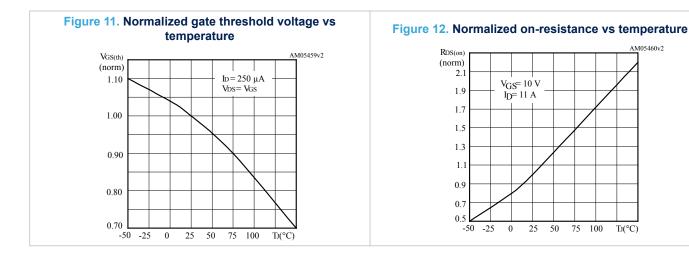




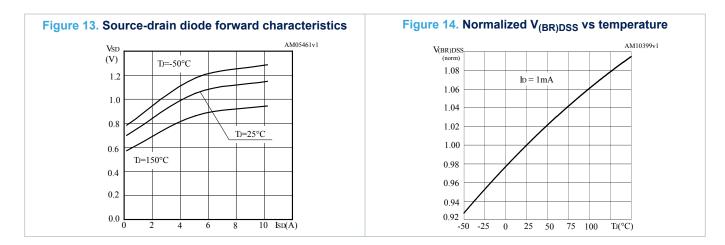


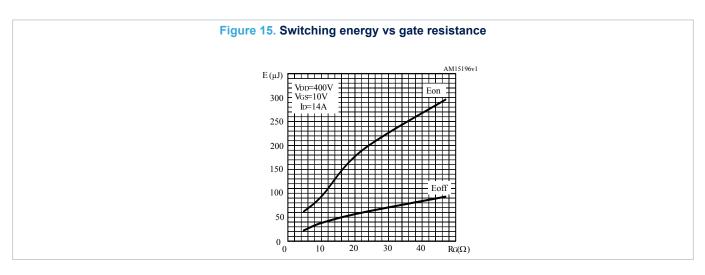
AM05460v2

TJ(°C)





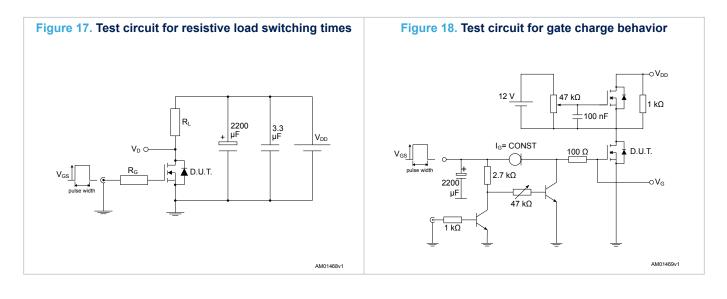


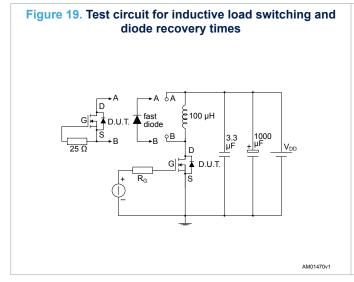


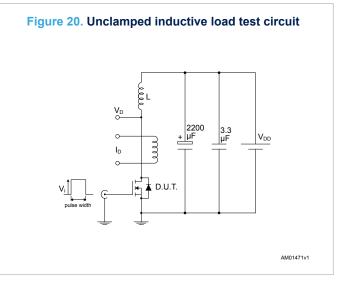
Note: *E*on including reverse recovery of a SiC diode.

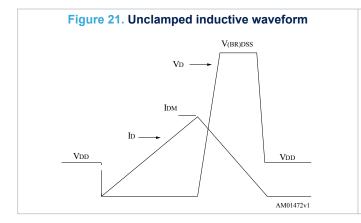


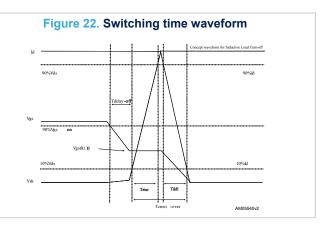
### 3 Test circuits













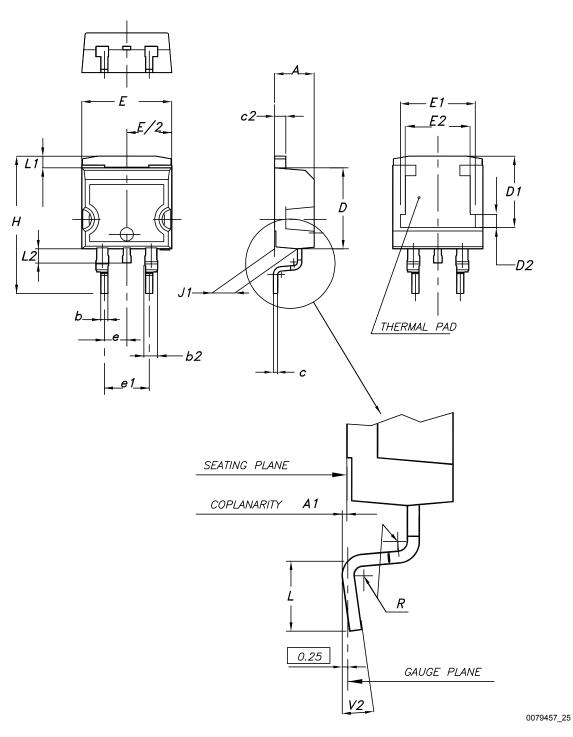
### 4 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK packages, depending on their level of environmental compliance. ECOPACK specifications, grade definitions and product status are available at: www.st.com. ECOPACK is an ST trademark.



### 4.1 D<sup>2</sup>PAK (TO-263) package information

Figure 23. D<sup>2</sup>PAK (TO-263) type A package outline



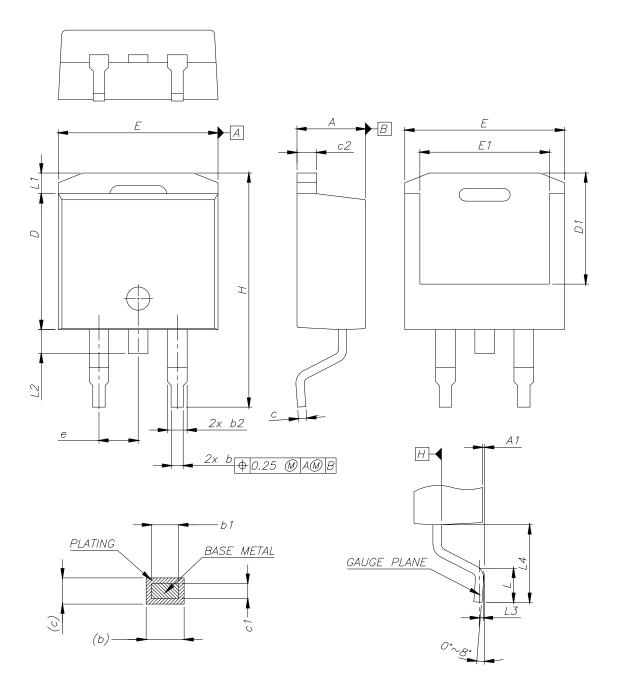


Dim.		mm	
Dim.	Min.	Тур.	Max.
A	4.40		4.60
A1	0.03		0.23
b	0.70		0.93
b2	1.14		1.70
С	0.45		0.60
c2	1.23		1.36
D	8.95		9.35
D1	7.50	7.75	8.00
D2	1.10	1.30	1.50
E	10.00		10.40
E1	8.30	8.50	8.70
E2	6.85	7.05	7.25
е		2.54	
e1	4.88		5.28
Н	15.00		15.85
J1	2.49		2.69
L	2.29		2.79
L1	1.27		1.40
L2	1.30		1.75
R		0.40	
V2	0°		8°

#### Table 8. D<sup>2</sup>PAK (TO-263) type A package mechanical data







0079457\_26\_B



Dim.		mm	
Dim.	Min.	Тур.	Max.
A	4.36		4.56
A1	0		0.25
b	0.70		0.90
b1	0.51		0.89
b2	1.17		1.37
С	0.38		0.694
c1	0.38		0.534
c2	1.19		1.34
D	8.60		9.00
D1	6.90		7.50
E	10.15		10.55
E1	8.10		8.70
e		2.54 BSC	
Н	15.00		15.60
L	1.90		2.50
L1			1.65
L2			1.78
L3		0.25	
L4	4.78		5.28

#### Table 9. D<sup>2</sup>PAK (TO-263) type B mechanical data



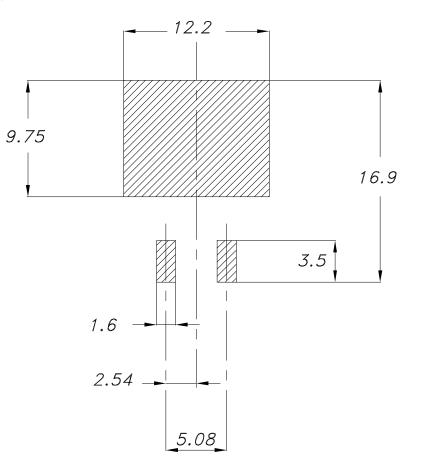
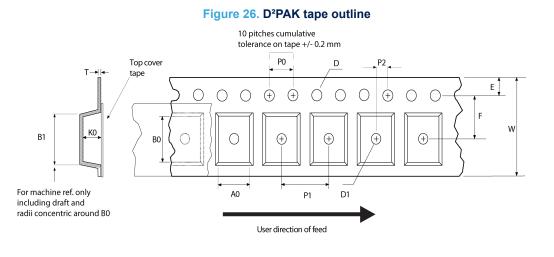


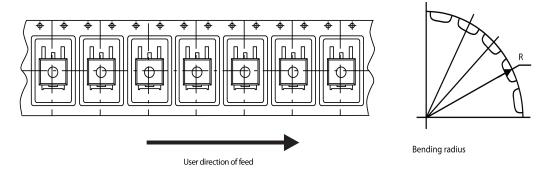
Figure 25. D<sup>2</sup>PAK (TO-263) recommended footprint (dimensions are in mm)

Footprint



### 4.2 D<sup>2</sup>PAK packing information



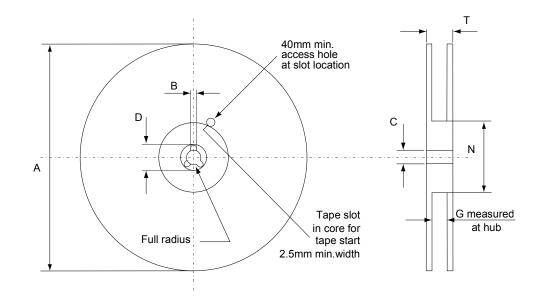


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#### STB31N65M5,STF31N65M5,STP31N65M5,STW31N65M5 D<sup>2</sup>PAK packing information

Figure 27. D<sup>2</sup>PAK reel outline



AM06038v1

Table 10. D <sup>2</sup> PAK tape and reel mechanical data
--

Таре		Reel				
Dim.	mm		Dim.	m	mm	
Dim.	Min.	Max.	Dini.	Min.	Max.	
A0	10.5	10.7	А		330	
B0	15.7	15.9	В	1.5		
D	1.5	1.6	С	12.8	13.2	
D1	1.59	1.61	D	20.2		
E	1.65	1.85	G	24.4	26.4	
F	11.4	11.6	N	100		
К0	4.8	5.0	Т		30.4	
P0	3.9	4.1				
P1	11.9	12.1	Base quantity 100		1000	
P2	1.9	2.1	Bulk quantity 1		1000	
R	50					
Т	0.25	0.35				
W	23.7	24.3				



### 4.3 D<sup>2</sup>PAK type B packing information

#### Figure 28. D<sup>2</sup>PAK type B tape outline

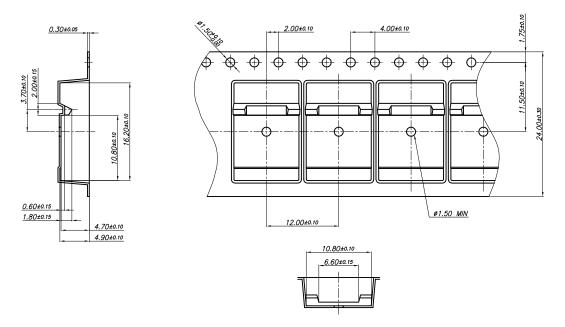
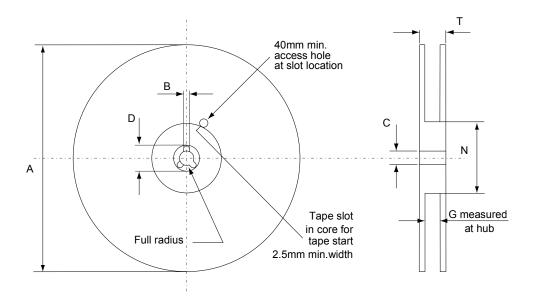


Figure 29. D<sup>2</sup>PAK type B reel outline



AM06038v1



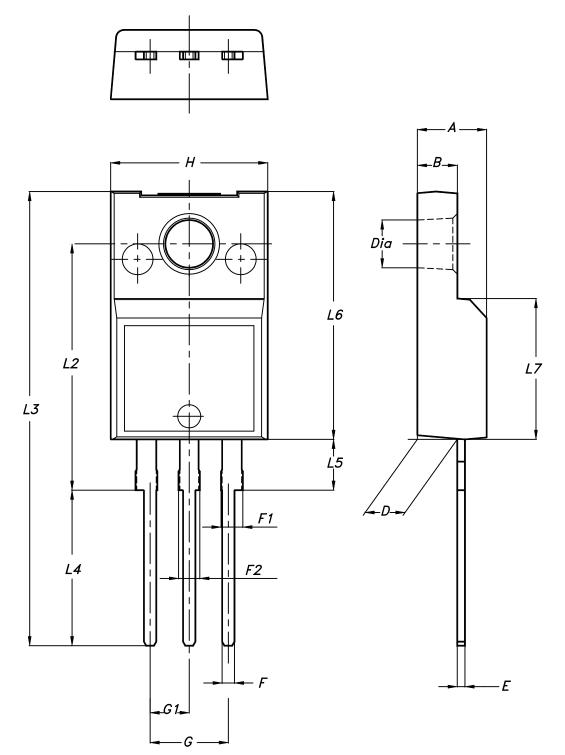
Table 11. D<sup>2</sup>PAK type B reel mechanical data

Dim.	mm		
Dini.	Min.	Max.	
A		330	
В	1.5		
С	12.8	13.2	
D	20.2		
G	24.4	26.4	
N	100		
Т		30.4	



### 4.4 TO-220FP package information

Figure 30. TO-220FP package outline



7012510\_Rev\_12\_B



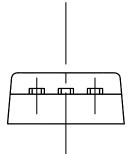
Dim.		mm		
	Min.	Тур.	Max.	
A	4.4		4.6	
В	2.5		2.7	
D	2.5		2.75	
E	0.45		0.7	
F	0.75		1	
F1	1.15		1.70	
F2	1.15		1.70	
G	4.95		5.2	
G1	2.4		2.7	
Н	10		10.4	
L2		16		
L3	28.6		30.6	
L4	9.8		10.6	
L5	2.9		3.6	
L6	15.9		16.4	
L7	9		9.3	
Dia	3		3.2	

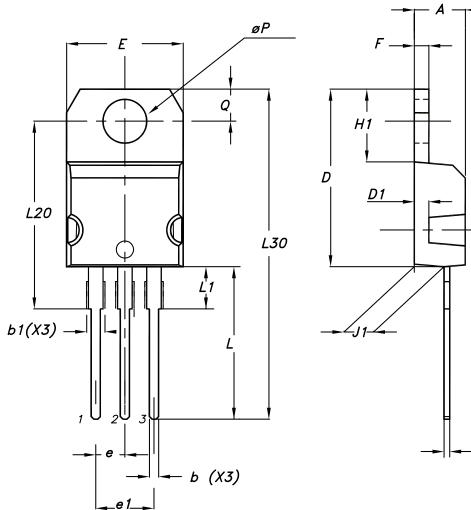
Table 12. TO-220FP package mechanical data



### 4.5 TO-220 type A package information

Figure 31. TO-220 type A package outline





0015988\_typeA\_Rev\_22

С



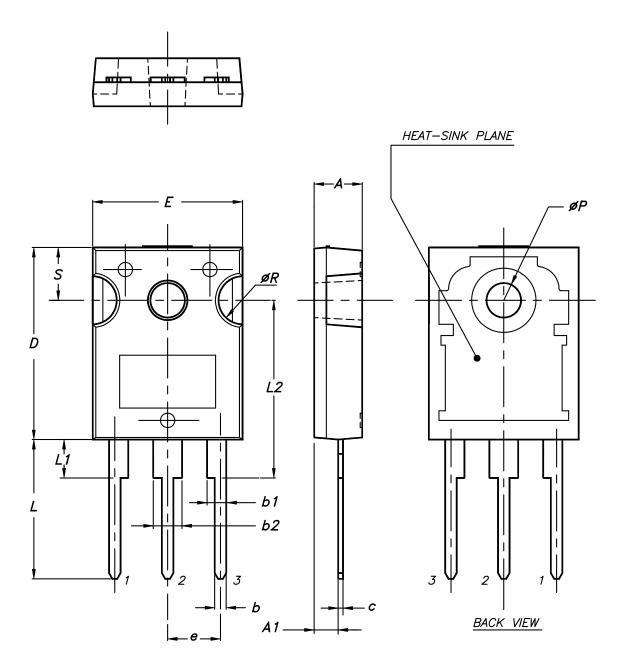
Dim.		mm	
	Min.	Тур.	Max.
A	4.40		4.60
b	0.61		0.88
b1	1.14		1.55
С	0.48		0.70
D	15.25		15.75
D1		1.27	
E	10.00		10.40
е	2.40		2.70
e1	4.95		5.15
F	1.23		1.32
H1	6.20		6.60
J1	2.40		2.72
L	13.00		14.00
L1	3.50		3.93
L20		16.40	
L30		28.90	
øP	3.75		3.85
Q	2.65		2.95

#### Table 13. TO-220 type A package mechanical data



### 4.6 TO-247 package information

Figure 32. TO-247 package outline



0075325\_9



Dim.	mm			
Dim.	Min.	Тур.	Max.	
A	4.85		5.15	
A1	2.20		2.60	
b	1.0		1.40	
b1	2.0		2.40	
b2	3.0		3.40	
С	0.40		0.80	
D	19.85		20.15	
E	15.45		15.75	
е	5.30	5.45	5.60	
L	14.20		14.80	
L1	3.70		4.30	
L2		18.50		
ØP	3.55		3.65	
ØR	4.50		5.50	
S	5.30	5.50	5.70	

Table 14. TO-247 package mechanical data



## 5 Ordering information

#### Table 15. Order codes

Order code	Marking	Package	Packing
STB31N65M5	31N65M5	D <sup>2</sup> PAK	Tape e reel
STF31N65M5		TO-220FP	
STP31N65M5		TO-220	Tube
STW31N65M5		TO-247	



### **Revision history**

#### Table 16. Document revision history

Date	Revision	Changes		
23-Feb-2012	1	First release.		
	2	– Modified note 2 under the Table 2.		
10-Sep-2012		- Updated typical values in Table 4, 5 and 6.		
10-3ep-2012		- Added Section 2.1.		
		– Minor text changes on the cover page.		
05-Mar-2013	3	Added dv/dt value on Table 2: Absolute maximum ratings.		
	4	The part number STFI31N65M5 has been moved to a separate datasheet.		
		Removed maturity status indication from cover page. The document status is production data.		
15-Apr-2019		Updated features and description in cover page.		
13-Api-2013		Updated Section 4 Package information.		
		Added Section 5 Ordering information.		
		Minor text changes.		



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	4.2	D <sup>2</sup> PAK packing information	15			
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